

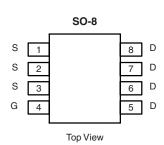
N-Channel 80-V (D-S) MOSFET

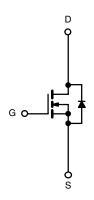
PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A)		
80	0.040 at V _{GS} = 10 V	7		
80	0.045 at V _{GS} = 6.0 V	6		

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFETs
- Compliant to RoHS Directive 2002/95/EC







N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	1A = 25 C, unites	ss officiwise i	loted	, ,	
Parameter		Symbol	10 s	Steady State	Unit
Drain-Source Voltage		V_{DS}	80		V
Gate-Source Voltage		V_{GS}	± 20		V
Outlines Prois Outline (T., 450,00)	T _A = 25 °C	I _D	7	6	
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 70 °C		6	4	
Pulsed Drain Current		I _{DM}	20		Α
Avalanche Current	L = 0.1 mH	I _{AS}	7		
Continuous Source Current (Diode Conduction) ^a		I _S	2.0	1.4	
Mariana Barray Disairation	T _A = 25 °C	P _D	2.5	1.3	W
Maximum Power Dissipation ^a	T _A = 70 °C	' D	1.8	1.0	VV
Operating Junction and Storage Temperature Rar	T _J , T _{stg}	- 55 t	o 150	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Manimum lumation to Amelianta	t ≤ 10 s	R _{thJA}	33	40	°C/W
Maximum Junction-to-Ambient ^a	Steady State	' ¹thJA	65	80	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	17	21	

Notes:

a. Surface Mounted on 1" x 1" FR4 board.



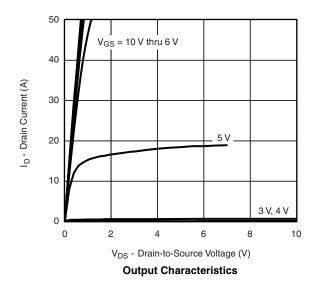
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.5		3	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zava Cata Valtana Busin Commant		V _{DS} = 64 V, V _{GS} = 0 V			1		
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = 64 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			5	μΑ	
On-State Drain Current ^a		$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	20			Α	
Drain-Source On-State Resistance ^a	_	$V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$		0.040		0	
	R _{DS(on)}	$V_{GS} = 6.0 \text{ V}, I_D = 8.0 \text{ A}$		0.045		Ω	
Forward Transconductancea	9 _{fs}	V _{DS} = 15 V, I _D = 10 A		20		S	
Diode Forward Voltage ^a	V_{SD}	$I_S = 2.8 \text{ A}, V_{GS} = 0 \text{ V}$		0.75	1.1	٧	
Dynamic ^b	l L		-1		<u> </u>		
Total Gate Charge	Qg			34	41		
Gate-Source Charge	Q _{gs}	$V_{DS} = 40 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 10 \text{ A}$		7.5		nC	
Gate-Drain Charge	Q_{gd}			11.0		1	
Gate Resistance	R_g		0.2	0.85	1.2	Ω	
Turn-On Delay Time	t _{d(on)}			17	25		
Rise Time	t _r	V_{DD} = 40 V, R_L = 40 Ω		11	17		
Turn-Off Delay Time	t _{d(off)}	$I_D\cong$ 1.0 A, V_{GEN} = 10 V, R_g = 6 Ω		40	60	ns	
Fall Time	t _f			31	45		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 2.8 A, dI/dt = 100 A/μs		45	75		

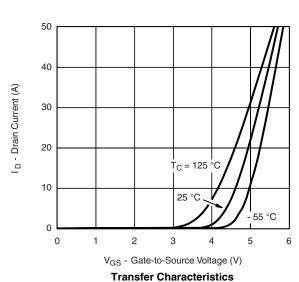
Notes:

- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

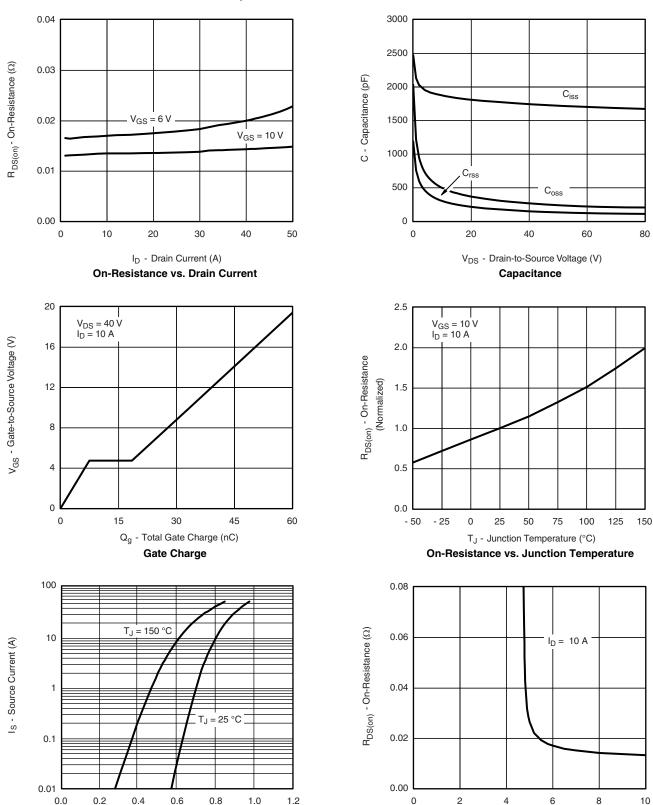




服务热线:400-655-8788



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



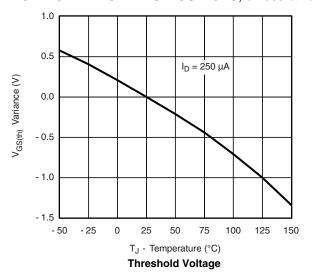
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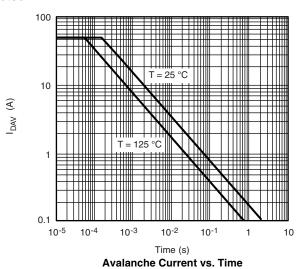
 V_{SD} - Source-to-Drain Voltage (V) **Source-Drain Diode Forward Voltage** V_{GS} - Gate-to-Source Voltage (V)

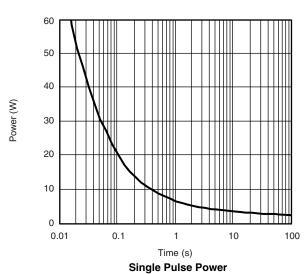
On-Resistance vs. Gate-to-Source Voltage

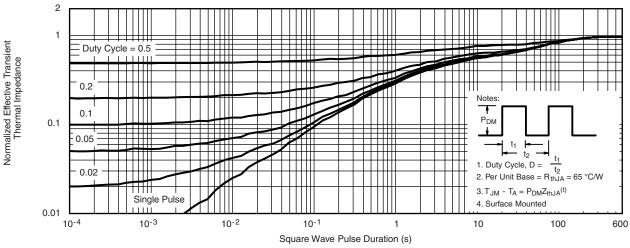


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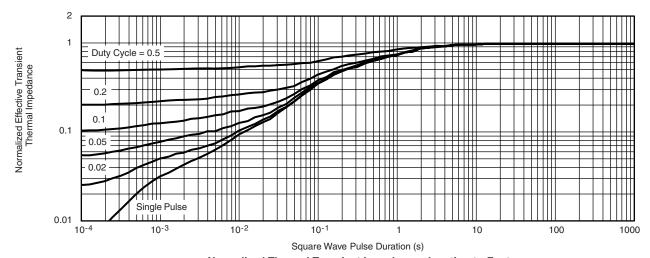




Normalized Thermal Transient Impedance, Junction-to-Ambient



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



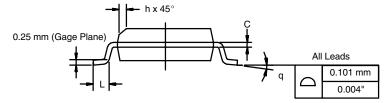
Normalized Thermal Transient Impedance, Junction-to-Foot



SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







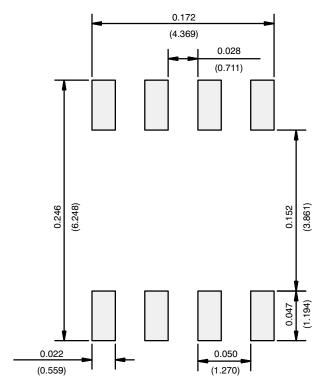
	MILLIM	IETERS	INC	HES		
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050 BSC			
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev L 11-Sep-06						

ECN: C-06527-Rev. I, 11-Sep-06

DWG: 5498



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)



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